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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Ray *et al.*

Examiner: Nguyen, Ha T

Serial No.: 09/779,812

Art Unit: 2812

Filed: 2/08/01

For: LEAD-FREE SOLDER STRUCTURE AND METHOD FOR HIGH FATIGUE LIFE

*Please enter  
6-23-03*  
Commissioner for Patents  
Washington, DC 20231

FAX RECEIVED

JUN 06 2003

TECHNOLOGY CENTER 2800

AMENDMENT

Sir:

In response to the Final Office Action mailed April 16, 2003, please amend the above-identified application as follows:

09/779,812

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*18/D(N.E)  
J. Steptoe  
6-11-03*